ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-American	burn, Illinois, A	ll rights reserved un ntions.	nder both	This docume level parts, t	ent is a declaration er	on of the subst acompasses all	ances within the manufac l lower level materials for	turer listed which the	item. Note: if manufacturer	the item is an as has engineering	ssembly with lower responsibility.	
52-21.1IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xForm Typ Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information												
Company name* Company unique ID				Unique ID Authority				Respo	Response Date*			
onsemi	emi								2024-04-19			
Contact Name	Title - Contact				Phone - Contact*			Email	Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	n Number	Mfr Item Name			Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type	
MC74/	74ACT163DG LOG CMOS COUN		NTER SYNCH		2024-04-19		PH1		142.69	mg	Each	
Manufacturing Proccess Information							-					
Terminal Plating / Grid Array Material	Terminal Base Alloy J-STD-020 M		-STD-020 MSL	Rating	Peak Process Body Temperature Max Time at Pe		ak Temper	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy 1					260	С	30	seco	onds 3			
Comments												
evel 1 - maximum time at peak temperature during s	oldering is 10-3	0 seconds										
For more information regarding material composition	n please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sign range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	2.73	mg	Supplier	Silicon (Si)	7440-21-3		2.73	mg	
Die Attach 4	4.85	mg	Supplier	Silver (Ag)	7440-22-4		3.6375	mg	
			Supplier	Epoxy resins	129915-35-1		1.2125	mg	
Lead Frame 75.92	75.92	mg	Supplier	Silver (Ag)	7440-22-4		0.7592	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.1518	mg	
			Supplier	Iron (Fe)	7439-89-6		1.9739	mg	
			Supplier	Copper (Cu)	7440-50-8		73.035	mg	
Mold Compound-Black 5.	55.11	mg		Epoxy Phenol Resin	proprietary data		5.7866	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		49.3234	mg	
Plating	3.73	mg	Supplier	Tin (Sn)	7440-31-5		3.73	mg	
Wire Bond - Au	0.35	mg	Supplier	Gold (Au)	7440-57-5		0.35	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signar range of distribution unless otherwise noted)